



DMN2028UFU

Product Summary

V _{(BR)DSS}	R _{DS} (ON) Max	Ι _D T _A = +25°C
20V	$20.2m\Omega @ V_{GS} = 4.5V$	7.5A
	$23.5 \text{m}\Omega @ \text{V}_{\text{GS}} = 2.5 \text{V}$	7.0A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Power Management Functions
- Battery Pack
- Load Switch

Low On-Resistance

- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed

Features

- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

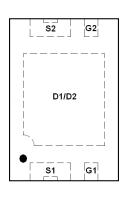
- Case: U-DFN2030-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.012 grams (Approximate)



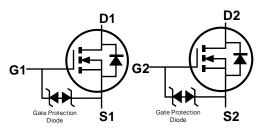


U-DFN2030-6

Bottom View



Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2028UFU-7	U-DFN2030-6	3000 / Tape & Reel
DMN2028UFU-13	U-DFN2030-6	10000 / Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



R23 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 14 for 2014) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±10	V
Continuous Drain Current (Note 6) V_{GS} = 4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	7.5 6.0	A
	t<10s	T _A = +25°C T _A = +70°C	Ι _D	9.9 7.9	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	40	A
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	12	А
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	8	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.9	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	144	°C/W	
memai Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ extsf{ heta}JA}$	84	C/VV	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.8	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	5	69	°C/W	
memai Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ heta JA}$	40		
Thermal Resistance, Junction to Case		$R_{ ext{ heta}JC}$	8.4		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	.		- 71-				
Drain-Source Breakdown Voltage	BV _{DSS}	20	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	I _{DSS}	—		1	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	—	—	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.5	—	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
			15.3	20.2		$V_{GS} = 4.5V, I_D = 4.5A$	
			15.4	22.5		$V_{GS} = 4.0V, I_D = 4.0A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	16.7	23.0	mΩ	$V_{GS} = 3.1 V, I_D = 4.0 A$	
			18.3	23.5		V _{GS} = 2.5V, I _D = 3.5A	
			24.2	30.0		V _{GS} = 1.8V, I _D = 3.5A	
Diode Forward Voltage	V _{SD}	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	—	887	—			
Output Capacitance	C _{oss}	—	91	—	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	—	37	—		1 = 1.000112	
Gate Resistance	Rg	-	191	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	10	—			
Total Gate Charge (V _{GS} = 8V)	Qg	-	18.4	-	nC	Vps = 10V. lp = 6.5A	
Gate-Source Charge	Q _{gs}	—	1.3	—	nc	$V_{DS} = 10V, I_{D} = 0.5A$	
Gate-Drain Charge	Q _{gd}	—	1.8	—			
Turn-On Delay Time	t _{D(ON)}	—	53	—			
Turn-On Rise Time	t _R	—	66	—		$V_{DS} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	—	619	—	ns	$R_G = 6\Omega$, $R_L = 10\Omega$, $I_D = 1A$	
Turn-Off Fall Time	t _F	—	197	—			
Reverse Recovery Time	t _{RR}	—	119	—	ns	I _F = 4A, di/dt = 100A/µs	
Reverse Recovery Charge	Q _{RR}		96	_	nC	I _F = 4A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

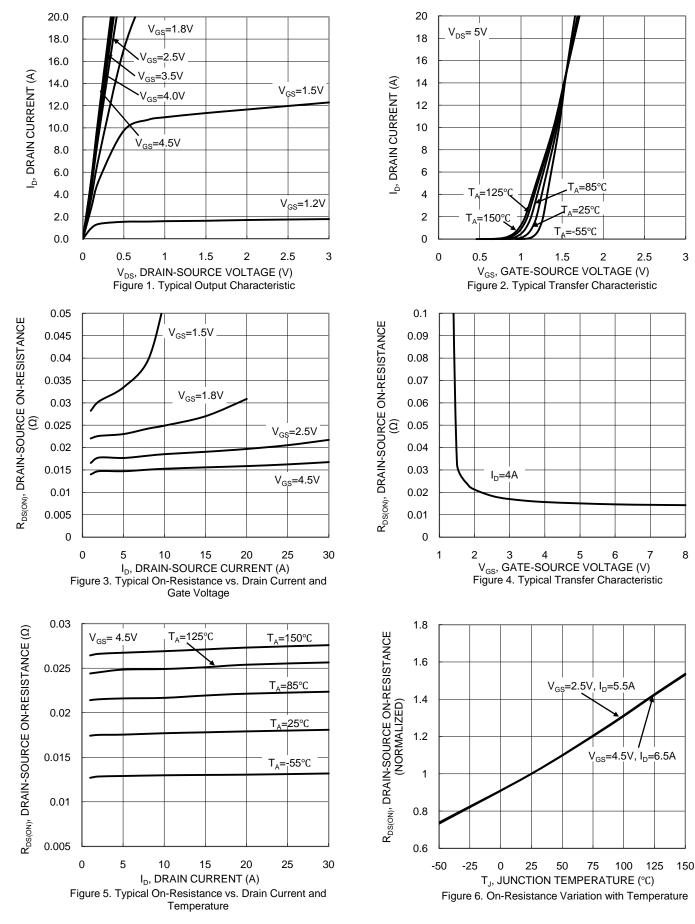
7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



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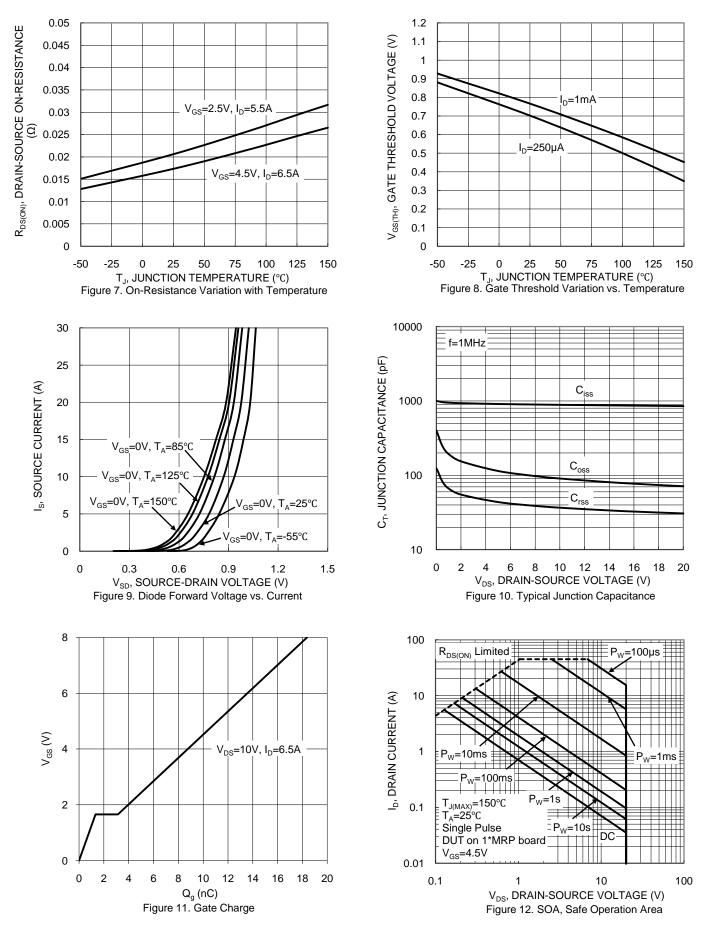


NEW PRODUCT

DMN2028UFU Document number: DS37945 Rev. 1 - 2

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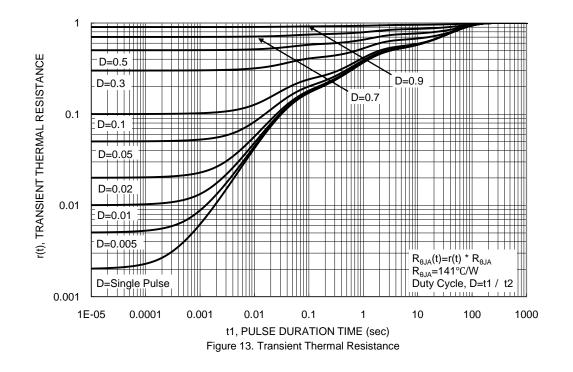


NEW PRODUCT

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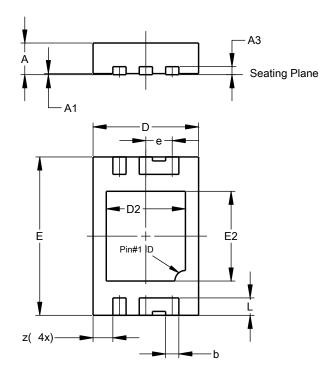
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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

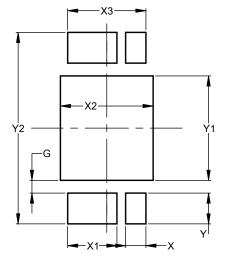


U-DFN2030-6 (Type B)					
Dim	Min	Max	Тур		
Α	0.55	0.65	0.60		
A1	0.00	0.05	0.02		
A3			0.15		
b	0.20	0.30	0.25		
D	1.95	2.05	2.00		
D2	1.40	1.60	1.50		
E	2.95	3.05	3.00		
E2	1.65	1.75	1.70		
e			0.50		
L	0.28	0.38	0.33		
z			0.375		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.220
Х	0.350
X1	0.850
X2	1.600
X3	1.350
Y	0.530
Y1	1.800
Y2	3.300

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